

SCES726-NOVEMBER 2008

16-BIT DUAL-SUPPLY BUS TRANSCEIVER WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

FEATURES

	VIEW)
1DIR 1 1B1 2 1B2 3	48 10E 47 1A1 46 1A2
GND 4 1B3 5	45 GND 44 1A3
1В4 [6 V _{ССВ} [7 1В5 [8	43 1A4 42 V _{CCA} 41 1A5
1B6 9 GND 10 187 11	40 1A6 39 GND 38 1A7
1B8 🛛 12	37 1A8 36 2A1
2B2 🛛 14	35 2A1 35 2A2 34 GND
	33 2A3
2B4 17	32 2A4
V _{ССВ} 🛛 18	31 🛛 V _{CCA}
2B5 🛛 19	30 2A5
2B6 🛛 20	29 2A6
	28 GND
-	27 2A7
	26 2A8
2DIR 24	25 2 <u>0E</u>
	1DIR [1 1B1 [2 1B2 [3 GND [4 1B3 [5 1B4 [6 V _{CCB} [7 1B5 [8 1B6 [9 GND [10 1B7 [11 1B8 [12 2B1 [13 2B2 [14 GND [15 2B3 [16 2B4 [17 V _{CCB} [18 2B5 [19

- **One Assembly/Test Site**
- **One Fabrication Site**
- Available in Military (-55°C/125°C) Temperature Ranges⁽¹⁾
- **Extended Product Life Cycle**
- **Extended Product-Change Notification**
- **Product Traceability**
- (1) Additional temperature ranges are available contact factory

DESCRIPTION/ORDERING INFORMATION

This 16-bit noninverting bus transceiver uses two separate configurable power-supply rails. The A port is designed to track V_{CCA}. V_{CCA} accepts any supply voltage from 1.65 V to 5.5 V. The B port is designed to track V_{CCB}. V_{CCB} accepts any supply voltage from 1.65 V to 5.5 V. This allows for universal low-voltage bidirectional translation between any of the 1.8-V, 2.5-V, 3.3-V, and 5-V voltage nodes.

The SN74LVCH16T245 is designed so that the control pins (1DIR, 2DIR, 1OE, and 2OE) are supplied by V_{CCA}.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



SCES726-NOVEMBER 2008

The SN74LVCH16T245 is designed for asynchronous communication between two data buses. The logic levels of the direction-control (DIR) input and the output-enable (OE) input activate either the B-port outputs or the A-port outputs or place both output ports into the high-impedance mode. The device transmits data from the A bus to the B bus when the B-port outputs are activated, and from the B bus to the A bus when the A-port outputs are activated. The input circuitry on both A and B ports is always active and must have a logic HIGH or LOW level applied to prevent excess I_{CC} and I_{CCZ}.

Active bus-hold circuitry holds unused or undriven data inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

This device is fully specified for partial-power-down applications using Ioff. The Ioff circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The V_{CC} isolation feature ensures that if either V_{CC} input is at GND, then all outputs are in the high-impedance state. The bus-hold circuitry on the powered-up side always stays active.

To ensure the high-impedance state during power up or power down, OE should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

ORDERING INFORMATION⁽¹⁾

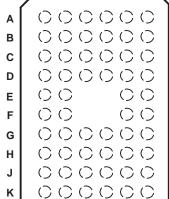
T _A	PACKAGE	(2)	ORDERABLE PART NUMBER	Top-Side Marking
–55°C to 125°C	TSSOP – DGG	Tape and reel	CLVCH16T245MDGGREP	8UT245MEP
-55 C 10 125 C	TVSOP – DGV	Tape and reel	CLVCH16T245MDGVREP	LDHT245MEP

For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI (1) web site at www.ti.com.

Package drawings, thermal data, and symbolization are available at www.ti.com/packaging. (2)

GQL OR ZQL PACKAGE (TOP VIEW)

1 2 3 4 5 6 000000



SN74LVCH16T245-EP



www.ti.com

SCES726-NOVEMBER 2008

		TEI	RMINAL ASSIG	NMENTS ⁽¹⁾			
	1	2	3	4	5	6	
Α	1DIR	NC	GND GND			1 <mark>0E</mark>	
В	1B2	1B1	GND	GND GND 1A1 V _{CCB} V _{CCA} 1A3			
С	1B4	1B3	V _{CCB}	1A4			
D	1B6	1B5	GND	GND	1A5	1A6	
E	1B8	1B7			1A7	1A8	
F	2B1	2B2			2A2	2A1	
G	2B3	2B4	GND	GND	2A4	2A3	
Н	2B5	2B6	V _{CCB}	V _{CCA}	2A6	2A5	
J	2B7	2B8	GND	GND	2A8	2A7	
К	2DIR	NC	3 4 5 NC NC NC GND GND 1A1 V _{CCB} V _{CCA} 1A3 GND GND 1A5 GND GND 1A7 2A2 GND GND 2A4 V _{CCB} V _{CCA} 2A6 1			2 <mark>0E</mark>	

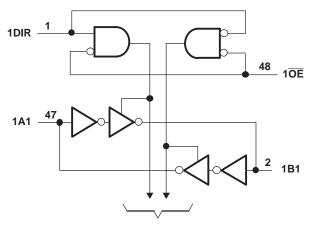
(1) NC – No internal connection

FUNCTION TABLE⁽¹⁾ (EACH 16-BIT SECTION)

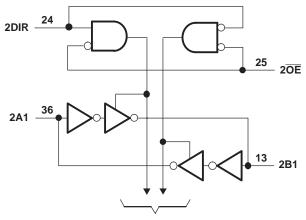
CONTRO	L INPUTS	OUTPUT C	IRCUITS	OPERATION
OE	DIR	A PORT	B PORT	OPERATION
L	L	Enabled	Hi-Z	B data to A bus
L	Н	Hi-Z	Enabled	A data to B bus
Н	Х	Hi-Z	Hi-Z	Isolation

(1) Input circuits of the data I/Os are always active.

LOGIC DIAGRAM (POSITIVE LOGIC)



To Seven Other Channels



To Seven Other Channels



SCES726-NOVEMBER 2008

Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V_{CCA} V_{CCB}	Supply voltage range		-0.5	6.5	V
		I/O ports (A port)	-0.5	6.5	
VI	Input voltage range ⁽²⁾	I/O ports (B port)	-0.5	6.5	V
		Control inputs	-0.5	6.5	
Vo	Voltage range applied to any output	A port	-0.5	6.5	V
	in the high-impedance or power-off state ⁽²⁾	B port	-0.5	6.5	v
V	Voltage range applied to any output in the high or low state $^{(2)(3)}$	A port	–0.5 V	_{CCA} + 0.5	V
Vo	voltage range applied to any output in the high of low state (B port	–0.5 V	_{ССВ} + 0.5	v
I _{IK}	Input clamp current	V ₁ < 0		-50	mA
I _{OK}	Output clamp current	V _O < 0		-50	mA
I _O	Continuous output current			±50	mA
	Continuous current through each V _{CCA} , V _{CCB} , and GND			±100	mA
θ_{JA}	Package thermal impedance ⁽⁴⁾	DGV package		58	°C/W
T _{stg}	Storage temperature range		-65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

(2)

(3) (4) The output positive-voltage rating may be exceeded up to 6.5 V maximum if the output current rating is observed.

The package thermal impedance is calculated in accordance with JESD 51-7.



SCES726-NOVEMBER 2008

Recommended Operating Conditions⁽¹⁾⁽²⁾⁽³⁾

			V _{CCI}	V _{cco}	MIN	MAX	UNIT
V _{CCA}	Supply voltage				1.65	5.5	V
V _{CCB}	Supply voltage				1.65	5.5	V
			1.65 V to 1.95 V		$V_{CCI} \times 0.65$		
. /	High-level	Data inputs ⁽⁴⁾	2.3 V to 2.7 V		1.7		V
VIH	input voltage	Data inputs	3 V to 3.6 V		2		V
			4.5 V to 5.5 V		$V_{CCI} \times 0.7$		
			1.65 V to 1.95 V			$V_{CCI} \times 0.35$	
,	Low-level	Data inputs ⁽⁴⁾	2.3 V to 2.7 V			0.7	V
VIL	input voltage	Data inputs	3 V to 3.6 V			0.8	V
			4.5 V to 5.5 V			$V_{CCI} \times 0.3$	
			1.65 V to 1.95 V		$V_{CCA} \times 0.65$		
. ,	High-level	Control inputs	2.3 V to 2.7 V		1.7		
VIH	input voltage	(referenced to V_{CCA}) ⁽⁵⁾	3 V to 3.6 V		2		V
			4.5 V to 5.5 V		$V_{CCA} \times 0.7$		
			1.65 V to 1.95 V			$V_{CCA} \times 0.35$	
	Low-level	Control inputs	2.3 V to 2.7 V			0.7	.,
VIL	input voltage	(referenced to V_{CCA}) ⁽⁵⁾	3 V to 3.6 V			0.8	V
			4.5 V to 5.5 V			$V_{CCA} \times 0.3$	
VI	Input voltage	Control inputs			0	5.5	V
.,		Active state			0	V _{cco}	V
V _{I/O}	Input/output voltage	3-State			0	5.5	V
				1.65 V to 1.95 V		-4	
				2.3 V to 2.7 V		-8	A
юн	High-level output cur	rent		3 V to 3.6 V		-24	mA
				4.5 V to 5.5 V		-32	
				1.65 V to 1.95 V		4	
				2.3 V to 2.7 V		8	A
OL	Low-level output curr	ent		3 V to 3.6 V		24	mA
				4.5 V to 5.5 V		32	
			1.65 V to 1.95 V			20	
∆t/	Input transition	Data insuta	2.3 V to 2.7 V			20	
Δv	rise or fall rate	Data inputs	3 V to 3.6 V			10	ns/V
			4.5 V to 5.5 V			5	
T _A	Operating free-air ter	nperature			-55	125	°C

(1)

(2)

 V_{CCI} is the V_{CC} associated with the data input port. V_{CCO} is the V_{CC} associated with the output port. All unused control inputs of the device must be held at V_{CCA} GND to ensure proper device operation and minimize power consumption. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004. For V_{CCI} values not specified in the data sheet, V_{IH} min = $V_{CCI} \times 0.7$ V, V_{IL} max = $V_{CCI} \times 0.3$ V. For V_{CCA} values not specified in the data sheet, V_{IH} min = $V_{CCA} \times 0.7$ V, V_{IL} max = $V_{CCA} \times 0.3$ V. (3)

- (4)
- (5)



SCES726-NOVEMBER 2008

Electrical Characteristics⁽¹⁾⁽²⁾

over recommended operating free-air temperature range (unless otherwise noted)

PAR	AMETER	TEST COND	ITIONS	V _{CCA}	V _{CCB}	MIN	TYP	MAX	MIN	MAX	UNIT
		I _{OH} = −100 μA,	$V_{I} = V_{IH}$	1.65 V to 4.5 V	1.65 V to 4.5 V				V _{CCO} - 0.1		
		I _{OH} = -4 mA,	$V_I = V_{IH}$	1.65 V	1.65 V				1.2		
V _{он}			$V_I = V_{IH}$	2.3 V	2.3 V				1.9		V
		I _{OH} = -24 mA,	$V_I = V_{IH}$	3 V	3 V				2.4		
			$V_I = V_{IH}$	4.5 V	4.5 V				3.8		
			$V_I = V_{IL}$	1.65 V to 4.5 V	1.65 V to 4.5 V					0.1	
			$V_I = V_{IL}$	1.65 V	1.65 V					0.45	
V _{OL}		I _{OL} = 8 mA,	$V_{I} = V_{IL}$	2.3 V	2.3 V					0.3	V
		I _{OL} = 24 mA,	$V_{I} = V_{IL}$	3 V	3 V					0.55	
		I _{OL} = 32 mA,	$V_{I} = V_{IL}$	4.5 V	4.5 V					0.55	
I _I	Control inputs	$V_{I} = V_{CCA}$ or GND		1.65 V to 5.5 V	1.65 V to 5.5 V		±0.5	±1		±3	μA
	1	V _I = 0.58 V		1.65 V	1.65 V				15		
(3)		V ₁ = 0.7 V		2.3 V	2.3 V				45		
BHL ⁽³⁾		V _I = 0.8 V		3 V	3 V				75		μA
		V _I = 0.1.35 V		4.5 V	4.5 V				100		
		V _I = 1.07 V		1.65 V	1.65 V				-15		
(4)		V _I = 1.7 V		2.3 V	2.3 V				-45		
внн ⁽⁴⁾		$V_1 = 2 V$		3 V	3 V				-75		μA
		V _I = 3.15 V		4.5 V	4.5 V				-100		
				1.95 V	1.95 V				200		
(5)			2.7 V	2.7 V				300		
BHLO ⁽⁵)	$V_{I} = 0$ to V_{CC}		3.6 V	3.6 V				500		μA
				5.5 V	5.5 V				900		
				1.95 V	1.95 V				-200		
(6	:)			2.7 V	2.7 V				-300		
внно ⁽⁶	')	$V_I = 0$ to V_{CC}		3.6 V	3.6 V				-500		μA
				5.5 V	5.5 V				-900		
	A port			0 V	0 to 5.5 V		±0.5	±1.5		±20	
off	B port	$V_1 \text{ or } V_0 = 0 \text{ to } 5.5$	V	0 to 5.5 V	0 V		±0.5	±1.5		±20	μA
	A or B port	$V_{O} = V_{CCO} \text{ or}$	$\overline{OE} = V_{IH}$	1.65 V to 5.5 V	1.65 V to 5.5 V			±1		±4	
ΟZ	B port	GND, V _I = V _{CCI} or GND	$\overline{OE} = don't$	0 V	5.5 V			±1		±4	μA
	A port		care	5.5 V	0 V			±1		±4	
	u		1	1.65 V to 5.5 V	1.65 V to 5.5 V					20	
CCA		$V_I = V_{CCI}$ or GND,	I _O = 0	5 V	0 V					20	μA
				0 V	5 V					-4	
				1.65 V to 5.5 V	1.65 V to 5.5 V					20	
ССВ		$V_{I} = V_{CCI}$ or GND,	I _O = 0	5 V	0 V					-4	μA
200			÷	0 V	5 V					20	•
I _{CCA} +		$V_{I} = V_{CCI}$ or GND,	$l_0 = 0$	1.65 V to 5.5 V	1.65 V to 5.5 V					30	μA

(1)

(2)

- An external driver must source at least I_{BHLO} to switch this node from low to high. An external driver must sink at least I_{BHHO} to switch this node from high to low. (5)
- (6)
- 6 Submit Documentation Feedback

 V_{CCO} is the V_{CC} associated with the output port. V_{CCI} is the V_{CC} associated with the input port. The bus-hold circuit can sink at least the minimum low sustaining current at V_{IL} max. I_{BHL} should be measured after lowering V_{IN} to GND (3) and then raising it to $V_{\text{IL}}\xspace$ max.

⁽⁴⁾ The bus-hold circuit can source at least the minimum high sustaining current at V_{IH} min. I_{BHH} should be measured after raising V_{IN} to V_{CC} and then lowering it to V_{IH} min.



SCES726-NOVEMBER 2008

Electrical Characteristics (continued)

over recommended operating free-air temperature range (unless otherwise noted)

PAR	AMETER	TEST CONDITIONS	V _{CCA}	V _{CCB}	MIN TYP MAX	MIN MAX	UNIT
ΔI _{CCA}	DIR	DIR at $V_{CCA} - 0.6 V$, B port = open, A port at V_{CCA} or GND	3 V to 5.5 V	3 V to 5.5 V		50	μΑ
C _i	Control inputs	$V_{I} = V_{CCA}$ or GND	3.3 V	3.3 V	4	5	pF
C _{io}	A or B port	$V_{O} = V_{CCA/B}$ or GND	3.3 V	3.3 V	8.5	10	pF

Switching Characteristics

over recommended operating free-air temperature range, $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO	V _{CCB} = ² ± 0.15		V _{CCB} = ± 0.2		V _{CCB} = ± 0.3		V _{ССВ} = ± 0.5		UNIT
	(INFUT)	(OUTPUT)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t _{PLH}	А	В	1.7	25.9	1.3	13.2	1	11.4	0.4	11.1	ns
t _{PHL}	A	В	1.7	20.9	1.5	13.2	-	11.4	0.4	11.1	115
t _{PLH}	В	А	0.9	27.8	0.8	27.8	0.7	27.4	0.7	27.4	ns
t _{PHL}	В	~	0.9	27.0	0.0	27.0	0.7	27.4	0.7	27.4	115
t _{PHZ}	OE	А	1.5	33.6	1.5	33.4	1.5	33.3	1.4	33.2	ns
t _{PLZ}	OL	~	1.5	55.0	1.5	55.4	1.5	55.5	1.4	55.Z	115
t _{PHZ}	OE	В	2.4	36.2	1.9	17.1	1.7	16	1.3	14.3	ns
t _{PLZ}	OL	В	2.4	30.2	1.9	17.1	1.7	10	1.5	14.5	115
t _{PZH}	OE	А	0.4	28	0.4	27.8	0.4	27.7	0.4	27.7	ns
t _{PZL}	OL	~	0.4	20	0.4	27.0	0.4	21.1	0.4	21.1	115
t _{PZH}	OE	В	1.8	36	1.5	22	1.2	16.6	0.9	14.8	ns
t _{PZL}	UE	В	1.0	30	1.5	22	1.2	10.0	0.9	14.0	115

Switching Characteristics

over recommended operating free-air temperature range, $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CCB} = ± 0.1		V _{CCB} = 2 ± 0.2		V _{CCB} = ± 0.3		V _{ССВ} = ± 0.5		UNIT
	(INFOT)	(001-01)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t _{PLH}	А	В	1.5	25.4	1.2	13	0.8	10.2	0.6	8.8	ns
t _{PHL}	~	В	1.5	20.4	1.2	15	0.0	10.2	0.0	0.0	115
t _{PLH}	В	А	1.2	13.3	1	13.1	1	12.9	0.9	12.8	ns
t _{PHL}	В	~	1.2	15.5	I	13.1	-	12.9	0.9	12.0	115
t _{PHZ}	OE	А	1.4	13	1.4	13	1.4	13	1.4	13	ns
t _{PLZ}	UL	~	1.4	15	1.4	15	1.4	15	1.4	15	115
t _{PHZ}	OE	В	2.3	33.6	1.8	14	1.7	14.3	0.9	10.9	20
t _{PLZ}	UE	D	2.3	33.0	1.0	14	1.7	14.5	0.9	10.9	ns
t _{PZH}	OE	А	1	14.9	1	14.9	1	14.9	1	14.9	20
t _{PZL}		A		14.9	I	14.9	I	14.9	I	14.9	ns
t _{PZH}	OE	В	1.7	32.2	1.5	16.9	1.2	13.4	1	10.9	20
t _{PZL}		D	1.7	3Z.Z	1.5	10.9	1.2	13.4	I	10.9	ns



SCES726-NOVEMBER 2008

Switching Characteristics

over recommended operating free-air temperature range, $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CCB} = 1 ± 0.15		V _{CCB} = ± 0.2		V _{CCB} = ± 0.3		V _{CCB} = ± 0.5		UNIT
	(INFOT)	(001-01)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t _{PLH}	A	В	1.6	25.2	1.1	12.8	0.8	10.2	0.6	8.4	ns
t _{PHL}	~	В	1.0	20.2	1.1	12.0	0.0	10.2	0.0	0.4	115
t _{PLH}	в	А	0.8	11.2	0.8	10.2	0.7	10.1	0.6	10	ns
t _{PHL}	В	~	0.0	11.2	0.0	10.2	0.7	10.1	0.0	10	115
t _{PHZ}	OE	А	1.6	12.2	1.6	12.2	1.6	12.2	1.6	12.2	ns
t _{PLZ}	OL	~	1.0	12.2	1.0	12.2	1.0	12.2	1.0	12.2	115
t _{PHZ}	OE	В	2.1	33	1.7	14.3	1.5	12.8	0.8	10.3	ns
t _{PLZ}	OL	В	2.1	55	1.7	14.5	1.5	12.0	0.0	10.5	115
t _{PZH}	OE	А	0.8	11.8	0.8	12.1	0.8	12.1	0.8	12.1	ns
t _{PZL}	UL UL	~	0.0	11.0	0.0	12.1	0.0	12.1	0.0	12.1	113
t _{PZH}	OE	В	1.8	3.7	1.4	16.4	1.1	12.5	0.8	10.4	ns
t _{PZL}	JE .	6	1.0	5.7	1.4	10.4	1.1	12.5	0.0	10.4	113

Switching Characteristics

over recommended operating free-air temperature range, $V_{CCA} = 5 V \pm 0.5 V$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 1 ± 0.15		V _{CC} = 2 ± 0.2		V _{CC} = 2 ± 0.3		V _{CC} = ± 0.5		UNIT
		(001F01)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t _{PLH}	A	В	1.5	25.4	1	12.8	0.7	10	0.4	8.2	ns
t _{PHL}	~	D	1.5	20.4	1	12.0	0.7	10	0.4	0.2	115
t _{PLH}	В	А	0.7	11	0.4	8.8	0.3	8.5	0.3	8.3	ns
t _{PHL}	D	~	0.7		0.4	0.0	0.5	0.5	0.5	0.5	115
t _{PHZ}	OE	А	0.3	9.4	0.3	9.4	0.3	9.4	0.3	9.4	ns
t _{PLZ}	OL	~	0.5	9.4	0.5	9.4	0.5	9.4	0.5	9.4	115
t _{PHZ}	OE	В	2	32.7	1.8	13.7	1.4	12	0.7	9.7	ns
t _{PLZ}	OL	В	2	52.1	1.0	13.7	1.4	12	0.7	9.7	115
t _{PZH}	OE	А	0.7	10.4	0.7	10.4	07	10.4	0.7	10.4	ns
t _{PZL}	UE	A	0.7	10.4	0.7	10.4	0.7	10.4	0.7	10.4	115
t _{PZH}	OE	В	1.5	31.6	12	15.4	1	12.1	0.9	10	ns
t _{PZL}	UL	В	1.5	51.0	1.3	13.4	I	12.1	0.9	10	115

Operating Characteristics

 $T_{A} = 25 = C$

PARAMETER		TEST CONDITIONS	V _{CCA} = V _{CCB} = 1.8 V TYP	V _{CCA} = V _{CCB} = 2.5 V TYP	V _{CCA} = V _{CCB} = 3.3 V TYP	V _{CCA} = V _{CCB} = 5 V TYP	UNIT
c (1)	A-port input, B-port output	$C_{L} = 0,$ f = 10 MHz, t _r = t _f = 1 ns	2	2	2	3	
C _{pdA} ⁽¹⁾	B-port input, A-port output		18	19	19	22	
C _{pdB} ⁽¹⁾	A-port input, B-port output		18	19	20	22	pF
	B-port input, A-port output		2	2	2	2	

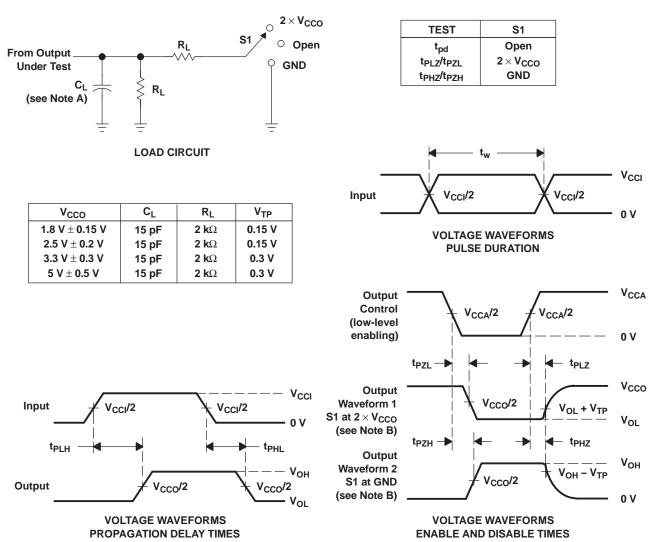
(1) Power dissipation capacitance per transceiver

SN74LVCH16T245-EP



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SCES726-NOVEMBER 2008



PARAMETER MEASUREMENT INFORMATION

- NOTES: A. CL includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , dv/dt \geq 1 V/ns, dv/dt \geq 1 V/ns.
 - D. The outputs are measured one at a time, with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .
 - H. V_{CCI} is the V_{CC} associated with the input port.
 - I. V_{CCO} is the V_{CC} associated with the output port.
 - J. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
CLVCH16T245MDGGREP	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CLVCH16T245MDGVREP	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
V62/09605-01XE	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
V62/09605-01YE	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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OTHER QUALIFIED VERSIONS OF SN74LVCH16T245-EP : • Catalog: SN74LVCH16T245

NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

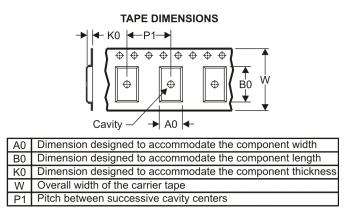
PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



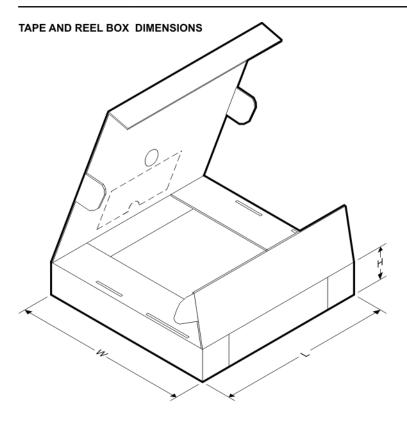
*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
CLVCH16T245MDGGRE P	TSSOP	DGG	48	2000	330.0	24.4	8.6	15.8	1.8	12.0	24.0	Q1
CLVCH16T245MDGVREP	TVSOP	DGV	48	2000	330.0	16.4	7.1	10.2	1.6	12.0	16.0	Q1

TEXAS INSTRUMENTS

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PACKAGE MATERIALS INFORMATION

11-Aug-2009



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
CLVCH16T245MDGGREP	TSSOP	DGG	48	2000	346.0	346.0	41.0
CLVCH16T245MDGVREP	TVSOP	DGV	48	2000	346.0	346.0	33.0

MECHANICAL DATA

MTSS003D - JANUARY 1995 - REVISED JANUARY 1998

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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